TECHNOLOGY

DEMO MANUAL DC094 DESIGN READY SWITCHER

LTC 1435 Constant Frequency Synchronous DC/DC Converter

DESCRIPTION

Demonstration Circuit 094 is a constant frequency stepdown (buck) regulator implemented entirely in surface mount using the LTC[®]1435 switching regulator controller. The output voltage is programmable from 1.8V to 5V via a jumper. The input voltage can range from 4.5V to 28V (limited by the external MOSFETs). The circuit highlights the capabilities of the LTC1435 which uses a current mode, constant frequency architecture to switch a pair of N-channel power MOSFETs while providing 99% maximum duty cycle. Operating efficiencies exceeding 90% are obtained. This results in a power supply that has very high efficiency, low ripple and fast transient response. At low output currents the LTC1435 automatically switches to Burst ModeTM operation to reduce switching losses and maintain high operating efficiencies. Additionally, the supply current can be shut down to less than 20μ A with an input voltage of 10V. This feature is an absolute necessity to maximize battery life in portable applications. **Gerber files for this circuit board are available. Call the LTC factory.**

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PERFORMANCE SUMMARY Operating Temperature Range 0°C to 50°C

| Input Voltage Range | Maximum Input Voltage (Limited by External MOSFET and Input Capacitor) | 4.5V to 28V |
|---------------------|--|----------------------------|
| Output | Output Voltage (Jumper Selectable) | 1.8V, 2.5V, 2.9V, 3.3V, 5V |
| | Maximum Output Current (Continuous) | 3A |
| | Maximum Output Current (Peak) | 3.5A |
| | Typical Output Ripple at 10MHz Bandwidth (Burst Mode Operation) I ₀ = 100mA | 50mV _{P-P} |
| | Typical Output Ripple at 10MHz Bandwidth (Continuous) I ₀ = 1A | 35mV _{P-P} |
| V _{IN} | Line Regulation, 6V to 20V | 0.002%/V |
| I _{OUT} | Load Regulation, No Load to Full Rated Output | -1% |
| Ι _Q | Supply Current with No Load at 10V Input (Typical), SFB = INT V_{CC} , EXT V_{CC} = 5V | 50μΑ |
| | Supply Current in Shutdown (Typical), V _{IN} = 10V | 15µA |
| IEXTVCC | EXT V _{CC} Pin Current, V _{EXTVCC} = 5V, V _{IN} = 10V, No Load | 650µA |
| V _{RUN} | Run Pin Threshold (Typical) | 1.3V |
| Frequency | Operating Frequency (Typical), C _{OSC} = 68pF | 170kHz |

TYPICAL PERFORMANCE CHARACTERISTICS AND BOARD PHOTO







PACKAGE A ID SCHEMATIC DIAGRAMS





PARTS LIST

| REFERENCE Designator | QUANTITY | PART NUMBER | DESCRIPTION | VENDOR | TELEPHONE |
|---------------------------------------|----------|------------------|-----------------------------------|----------|----------------|
| C _C | 1 | 08055A331KAT1A | 330pF 50V 10% NPO Chip Capacitor | AVX | (803) 448-9411 |
| C _{C2} | 1 | 08055A510KAT1A | 51pF 50V 10% NPO Chip Capacitor | AVX | (803) 448-9411 |
| C _{IN1} , C _{IN2} | 2 | TPSE226M035 | 22µF 35V 20% Tantalum Capacitor | AVX | (803) 448-9411 |
| C _{OSC} | 1 | 08055A680JAT1A | 68pF 50V 5% NPO Chip Capacitor | AVX | (803) 448-9411 |
| C _{OUT1} , C _{OUT2} | 2 | TPSD107M010R0080 | 100µF 10V 20% Tantalum Capacitor | AVX | (803) 448-9411 |
| C1, C6 | 2 | 08055A101KAT1A | 100pF 50V 10% NPO Chip Capacitor | AVX | (803) 448-9411 |
| C2, C4, C _{SS} | 3 | 08055G104KAT1A | 0.1µF 50V 10% Y5V Chip Capacitor | AVX | (803) 448-9411 |
| C3 | 1 | TAJB475M016 | 4.7µF 16V 20% Tantalum Capacitor | AVX | (803) 448-9411 |
| C5 | 1 | 08055C102KAT1A | 1000pF 50V 10% X7R Chip Capacitor | AVX | (803) 448-9411 |
| D1 | 1 | CMDSH-3 | BVR = 30V Schottky Diode | Central | (516) 435-1110 |
| D2 | 1 | MBRS140T3 | BVR = 40V Schottky Diode | Motorola | (602) 244-3576 |
| E1 to E8 | 8 | 1502-2 | Turret Terminal | Keystone | (718) 956-8900 |



PARTS LIST

| REFERENCE Designator | QUANTITY | PART NUMBER | DESCRIPTION | VENDOR | TELEPHONE |
|-------------------------|----------|--------------------------|--|------------------|----------------|
| JP1 | 1 | 2802S-03-G2 | 2mm Pin Header | Comm Con | (818) 301-4200 |
| JP2 | 1 | 2802S-10-G2 | 2mm Pin Header | Comm Con | (818) 301-4200 |
| L1 | 1 | CDRH125-10 CDRH127-10 | 10μH Inductor 10μH Inductor (Alternate) | Sumida Sumida | (708) 956-0666 |
| Q1, Q2 | 2 | Si4412DY | N-Channel MOSFET | Siliconix | (800) 554-5565 |
| R1 | 1 | CR21-3572F-T | 35.7k 1/10W 1% Chip Resistor | AVX | (803) 448-9411 |
| R2 | 1 | CR21-6982F-T | 69.8k 1/10W 1% Chip Resistor | AVX | (803) 448-9411 |
| R3 | 1 | CR21-3242F-T | 32.4k 1/10W 1% Chip Resistor | AVX | (803) 448-9411 |
| R4 | 1 | CR21-2492F-T | 24.9k 1/10W 1% Chip Resistor | AVX | (803) 448-9411 |
| R5 | 1 | CR21-2002F-T | 20k 1/10W 1% Chip Resistor | AVX | (803) 448-9411 |
| R6 | 1 | CR21-1102F-T | 11k 1/10W 1% Chip Resistor | AVX | (803) 448-9411 |
| R _C | 1 | CR21-103J-T | 10k 1/10W 5% Chip Resistor | AVX | (803) 448-9411 |
| R _{SENSE} | 1 | LR2010-01-R033-F | 0.033Ω 1/2W 1% Resistor | IRC | (512) 992-7900 |
| U1 | 1 | LTC1435CS | 16-Lead Narrow Small Outline IC | LTC | (408) 432-1900 |
| | 2 | CCIJ2mm-138-G | Jumper | Comm Con | (818) 301-4200 |

QUICK START GUIDE

This demonstration board is easy to set up to evaluate the performance of the LTC1435. Please follow the procedure outlined below for proper operation.

- 1. Refer to Figure 3 for proper arrangement of monitoring equipment for correct measurement equipment setup.
- 2. Connect the input power supply to the V_{IN} and GND terminals on the left-hand side of the board. Do not increase V_{IN} over 28V or the MOSFET(s) *will be damaged*. At lower output voltages (V_{OUT} \leq 2.5V) the maximum input voltage must be decreased. See Table 1.
- 3. Connect the load between the V_{OUT} and GND terminals on the right side of the board.
- 4. The RUN pin can be left unconnected. To shut down the LTC1435 tie this pin to ground.
- 5. When the 5V output voltage option is selected externally connect EXT V_{CC} to $V_{OUT}.$
- 6. Set the jumper JP1 so that SFB is connected to INT $V_{CC}.$

7. Set the desired output voltage with jumper JP2 shown in Figure 2 and Table 1.

Table 1. Maximum Allowable Input Voltage vs SelectedOutput Voltage

| POSITION | OUTPUT VOLTAGE | MAXIMUM INPUT Voltage |
|----------|----------------|--------------------------|
| А | 1.8V | 18V |
| В | 2.5V | 24V |
| С | 2.9V | 28V |
| D | 3.3V | 28V |
| E | 5V | 28V |



Figure 2. Output Voltage Selection (JP2) (3.3V Position Shown)

INTRODUCTION

The circuit in Figure 1 highlights the capabilities of the LTC1435. The application circuit is set up for a variety of output voltages. Output voltages from 1.8V to 5V are available by selecting the appropriate jumper position.

The LTC1435 is a synchronous step-down switching regulator controller which drives external N-channel power MOSFETs using a fixed frequency architecture. Burst Mode operation provides high efficiency at low load currents. Operating efficiencies typically exceed 90% over three decades of load current range. A maximum high duty

cycle limit of 99% provides low dropout operation which extends operating time in battery-operated systems.

The use of small spring-clip leads are very convenient for small-signal bench testing and voltage measurements, but should not be used with the high currents associated with this circuit. Soldered wire connections are required to properly ascertain the performance of the PC board.

This demonstration unit is intended for the evaluation of the LTC1435 switching regulator IC and was not designed for any other purpose.

OPERATION

The operating frequency is set by an external capacitor C_{OSC} , allowing maximum flexibility in optimizing efficiency. In this application the frequency is set to 170kHz. A secondary winding feedback control pin SFB inhibits Burst Mode which reduces noise and RF interference.

Soft start is provided by an external capacitor C_{SS} which can be used to properly sequence supplies. The operating current level is user-programmable via an external current sense resistor and is set to 3A. Short-circuit current limit is set approximately to 4A.

This demo board is optimized for 3.3V outputs. A wide input supply range allows operation from 4.5V to 28V for V_{OUT} voltages of 3.3V and 5V. Because this board allows for a wide output voltage range (1.8V to 5V) and the operating frequency remains constant at 170kHz, there is a duty cycle induced limit on the maximum input voltage when low output voltages are selected (V_{OUT} < 2.9V). This is necessary for an adequate turn-on time for the top MOSFET with the required duty cycle at a given frequency. If a higher input supply voltage is required together with low output voltage, the operating frequency can be decreased by increasing C_{OSC}.

Main Control Loop

The LTC1435 uses a constant frequency, current mode step-down architecture. Current mode operation was judged to be mandatory for its well-known advantages of

clean start-up, accurate current limit and excellent line and load regulation.

During normal operation, the top MOSFET is turned on each cycle when the oscillator sets a latch and turned off when the main current comparator resets the latch. The peak inductor current is controlled by the voltage on the I_{TH} pin, which is the output of error amplifier EA.

The V_{OSENSE} pin allows EA to receive an output feedback voltage V_{FB} from an external resistive divider. When the load current increases, it causes a slight decrease in V_{FB} relative to the 1.19V reference, which in turn causes the I_{TH} voltage to increase until the average inductor current matches the new load current. While the top MOSFET is off, the bottom MOSFET is turned on until either the inductor current starts to reverse or the beginning of the next cycle.

The top MOSFET driver is biased from floating bootstrap capacitor C4, which normally is recharged during each off cycle. However, when V_{IN} decreases to a voltage close to V_{OUT} , the loop may enter dropout and attempt to turn on the top MOSFET continuously. The dropout detector counts the number of oscillator cycles that the top MOSFET remains on and periodically forces a brief off period to allow C4 to recharge.

A built-in comparator guards against transient overshoots > 7.5% by turning off the top MOSFET and keeping it off until the fault is removed.



OPERATION

Low Current Operation

The LTC1435 is capable of Burst Mode operation in which the external MOSFETs operate intermittently based on load demand. If the voltage across R_{SENSE} does not exceed approximately 20mV for one full cycle, then on following cycles the top and bottom drives are disabled. This continues until the I_{TH} voltage exceeds 0.6V, which causes drive to be returned to the top MOSFET on the next cycle.

Two conditions can force continuous synchronous operation, even when the load current would otherwise dictate low current operation. One is when the common mode voltage of the Sense⁺ and Sense⁻ pins is below 1.4V, and the other is when the SFB pin is below 1.19V. See the SFB pin function description.

INT V_{CC}/EXT V_{CC} Power

Power for the top and bottom MOSFET drivers and most of the other LTC1435 circuitry is derived from INT V_{CC} pin. When the EXT V_{CC} pin is left open, an internal 5V low dropout regulator supplies INT V_{CC} power. If EXT V_{CC} is taken above 4.7V, the 5V regulator is turned off and an internal switch is turned on to connect EXT V_{CC} to INT V_{CC}. This allows the INT V_{CC} power to be derived from a high efficiency external source such as the output of the regulator itself or a secondary winding, as described in the LTC1435 data sheet.

When the 5V output voltage option is selected (JP2E installed) the EXT V_{CC} pin should be externally connected to $V_{OUT}.$

HOW TO MEASURE VOLTAGE REGULATION

When trying to measure voltage regulation, remember that all measurements must be taken at the point of regulation. This point is where the LTC1435's control loop looks for the information to keep the output voltage constant. In this demonstration board this information point occurs between Pin 5 of the LTC1435, the signal ground, and the output side of R1. These points correspond to the V_{OSENSE} (E7) terminal of the board. Output voltage test leads should be attached directly to this

terminal. The load should be placed across V_{OUT} (E6) to GND (E8). Measurements *should not* be taken at the end of test leads at the load. Refer to Figure 3 for the proper monitoring equipment configuration.

This applies to line regulation (input to output voltage regulation) as well as load regulation tests. In doing line regulation tests always look at the input voltage across the input terminals.

For the purposes of these tests the demonstration circuit should be fed from a regulated DC bench supply so additional variation on the DC input does not add an error to the regulation measurements.



Figure 3. Proper Measurement Setup

REMOTE OUTPUT VOLTAGE SENSING

Remote output voltage sensing can be accomplished by modifying the PC board. A small PC trace connecting V_{OUT} to V_{OSENSE} must be cut as shown in Figure 4. An external connection from V_{OSENSE} directly across the load must be made. To prevent uncertainty, solder a 10Ω resistor across the V_{OUT} and V_{OSENSE} terminals. Never, under any circumstance, allow V_{OSENSE} to float!



OPERATION



Figure 4. Remote Output Voltage Sense

INT V_{CC} Regulator

An internal P-channel low dropout regulator produces the 5V supply which powers the drivers and internal circuitry within the LTC1435. The INT V_{CC} pin can supply up to 15mA (this includes the gate drive currents). External loading of the INT V_{CC} pin may be up to 10mA. At high input voltages the maximum junction temperature rating for the LTC1435 may be exceeded if too large an external load is placed on INT V_{CC} . See the LTC1435 data sheet for further details.

EXT V_{CC} Connection

The LTC1435 contains an internal P-channel MOSFET switch connected between the EXT V_{CC} and INT V_{CC} pins. The switch closes and supplies the INT V_{CC} power whenever the EXT V_{CC} pin is above 4.7V and remains closed until EXT V_{CC} drops below 4.5V. This allows the MOSFET driver and control power to be derived from the output during normal operation (4.7V < V_{OUT} \leq 9V) and from the internal regulator when the output is out of regulation (start-up, short circuit). Do not apply greater than 10V to the EXT V_{CC} pin and ensure that EXT V_{CC} \leq V_{IN}.

Significant efficiency gains can be realized by powering INT V_{CC} from the output, since the V_{IN} current resulting from the driver and control currents will be scaled by a factor of (Duty Cycle)/(Efficiency). For 5V regulators this simply means connecting the EXT V_{CC} pin directly to V_{OUT}.

However, for 3.3V and other lower voltage regulators, additional circuitry is required to derive INT V_{CC} power from the output.

The following list summarizes the four possible connections for EXT $V_{\mbox{CC}:}$

- 1. EXT V_{CC} Left Open (or Grounded). This will cause INT V_{CC} to be powered from the internal 5V regulator resulting in an efficiency penalty of up to 10% at high input voltages.
- 2. EXT V_{CC} Connected Directly to V_{OUT} . This is the normal connection for a 5V regulator and provides the highest efficiency.
- 3. EXT V_{CC} Connected to an Output-Derived Boost Network. For 3.3V and other low voltage regulators, efficiency gains can still be realized by connecting EXT V_{CC} to an output-derived voltage which has been boosted to greater than 4.7V. See the LTC1435 data sheet for further details.
- 4. EXT V_{CC} Connected to an External Supply. If an external supply is available in the 5V to 10V range (EXT V_{CC} \leq V_{IN}), it may be used to power EXT V_{CC} providing an efficiency boost.

SFB Pin Function (Burst Mode Disable)

When the SFB (E4) pin drops below its ground-referenced 1.19V threshold, continuous mode operation is forced (Burst Mode is inhibited). In continuous mode the N-channel main and synchronous switches are continuously switched irrelevant of the load on the main output. This reduces noise and interference but impacts efficiency. Jumper JP1 sets the voltage on SFB and is set as follows:

| <u>SFB</u> | <u>Condition</u> |
|---------------------|----------------------|
| GND | Burst Mode Inhibited |
| INT V _{CC} | Burst Mode Enabled |

In addition to providing a logic input to force continuous synchronous operation, the SFB pin provides a means to regulate a flyback winding output. See the LTC1435 data sheet for additional information.



OPERATION

When the SFB pin is left floating (no jumper installed at J1) Burst Mode is enabled. *Do not apply an external voltage to SFB (E4) when the jumper JP1 is installed!*

Run/Soft Start Function

The Run/SS pin (E3) is a dual purpose pin which provides the soft start function and a means to shut down the LTC1435. Soft start reduces surge currents from $V_{\rm IN}$ by gradually increasing the internal current limit. **Power supply sequencing** can also be accomplished using this pin.

An internal 3µA current source charges up an external capacitor C_{SS.} When the voltage on Run/SS reaches 1.3V the LTC1435 begins operating. As the voltage on Run/SS continues to ramp from 1.3V to 2.4V, the internal current limit is also ramped at a proportional linear rate. The current limit begins at approximately 50mV/R_{SENSE} (at V_{RUN/SS} = 1.3V) and ends at 150mV/R_{SENSE} (V_{RUN/SS} ≤

2.7V). The output current thus ramps up slowly, charging the output capacitor. If Run/SS has been pulled all the way to ground there is a delay before starting of approximately 500ms/ μ F, followed by an additional 500ms/ μ F to reach full current. C_{SS} = 0.1 μ F on this PC board.

Pulling the Run/SS pin below 1.3V puts the LTC1435 into a low quiescent current shutdown ($I_Q < 20\mu A$). The Run/SS pin has an internal 6V Zener clamp (see the data sheet for further information).

Component Manufacturers

Following is a partial list of component manufacturers which can be used in LTC1435 applications. Using components other than the ones supplied on the demonstration board will require careful analysis to verify that all component specifications are not exceeded. Finally, recharacterizing the circuit for efficiency is necessary.

| MANUFACTURER | DEVICE | TELEPHONE | FAX |
|--------------------------|---------------------------|-------------------------------------|-------------------------------------|
| AVX | Capacitors | (803) 448-9411 | (803) 448-1943 |
| Central Semiconductor | Diodes | (516) 435-1110 | (516) 435-1824 |
| Coilcraft | Inductors | (708) 639-6400 | (708) 639-1469 |
| Coiltronics | Inductors | (407) 241-7876 | (407) 241-9339 |
| Comm Con | Connectors | (818) 301-4200 | (818) 301-4212 |
| Dale | Inductors/Sense Resistors | (605) 665-9301 | (605) 665-0817 |
| International Rectifiers | MOSFETs/Diodes | (310) 322-3331 | (310) 322-3332 |
| IRC | Sense Resistors | (512) 992-7900 | (512) 992-3377 |
| KRL | Sense Resistors | (603) 668-3210 | (603) 624-0634 |
| Motorola | MOSFETs/Diodes | (602) 244-3576 | (602) 244-4015 |
| Murata-Erie | Capacitors | (770) 436-1300 | (770) 436-3030 |
| Sanyo | Capacitors/MOSFETs | (619) 661-6835 [81] 0952-82-3959 | (619) 661-1055 [81] 0952-82-4655 |
| Siliconix | MOSFETs | (800) 554-5565 | (408) 970-3979 |
| Sprague | Capacitors | (603) 224-1961 | (603) 224-1430 |
| Sumida | Inductors | (708) 956-0666 [81] 03-3607-5111 | (708) 956-0702 [81] 03-3607-5144 |
| TDK | Inductors | (708) 803-6100 | [81] 03-3278-5358 |



PCB LAYOUT AND FILM



Component Side Silkscreen



Component Side



Solder Side

((....)

Solder Side Solder Mask

PC FAB DRAWING



HOLE CHART

| SYMBOL | DIAMETER | # OF HOLES | PLATED | | |
|----------|-------------|------------|--------|--|--|
| A | 0.125 | 3 | NO | | |
| В | 0.030 | 260 | YES | | |
| С | 0.094 | 22 | NO | | |
| D | 0.070 | 40 | NO | | |
| E | 0.094 | 160 | YES | | |
| UNMARKED | 0.018 | 440 | YES | | |
| | TOTAL HOLES | 945 | | | |

NOTES:

- 1. MATERIAL IS FR4, 0.062" WITH 2 OZ COPPER
- 2. PCB WILL BE DOUBLE SIDED WITH PLATED THROUGH HOLES
- 3. HOLE SIZES ARE AFTER PLATING. PLATED THROUGH HOLE WALL THICKNESS MIN 0.0014" (1 OZ)
- 4. USE PADMASTER PROCESS
- 5. SOLDER MASK BOTH SIDES WITH PC401 USING FILM PROVIDED
- 6. SILKSCREEN COMPONENT SIDE USING FILM PROVIDED. USE WHITE, NONCONDUCTIVE INK
- 7. ALL DIMENSIONS ARE IN INCHES ±0.005
- 8. ALL PANELS IN ORDER MUST BE THE SAME DIMENSIONS $\pm\,0.030"$
- 9. DO NOT PLATE TOOLING HOLES 0.125
- 10. DO NOT PLATE SCORING HOLES (22 HOLES 0.094 AT PANEL EDGE) DO NOT PLATE ALIGNMENT HOLES - 40 HOLES 0.070"
- 11. SCORE BOTH SIDES LEAVING 0.017 0.002 + 0.000 THICKNESS
- 12. ALL HOLE SIZES AFTER PLATING + 0.003/- 0.

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